

He B Comulty Patent My 201

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:)
Andideh, E. et al.))
U.S. Serial No: 09/436,092	Examiner: McDonald, S.
Filed: November 8, 1999) Art Unit: 3723
For: POLISH PAD WITH NON-UNIFORM GROOVE DEPTH TO IMPROVE WAFER POLISH RATE UNIFORMITY	Examiner: McDonald, S. Art Unit: 3723
Assistant Commissioner for Patents Washington, D.C. 20231	
AMENDMENT AND RESPONSE	
Dear Sir:	
This is in response to the Office A	ction mailed September 27, 2000. Applicant
respectfully requests the Examiner to enter the following amendments and consider	
the following remarks.	
	E MAIL INC
FIRST CLASS CERTIFICATE O I hereby certify that this correspondence is being deposited w sufficient postage in an envelope addressed to the Assistant	with the United States Postal Service as first class mail with
onJanuary 11, 2001	
Teresa Edwards Name of Person Mailing Correspondence	
Jarso Edwards	January 11, 2001
Signature	V Vale